

## **RoHS Statement of Compliance**

We declare that all products sold by Allectra GmbH are designed to be RoHS compliant according to:

Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment, superseded by:

Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (recast), changed by:

Commission Delegated Directive (EU) 2015/863 of 31 March 2015 amending Annex II to Directive 2011/65/EU of the European Parliament and of the Council as regards the list of restricted substances and:

Directive (EU) 2017/2102 of the European Parliament and of the Council of 15 November 2017 amending Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS restricts the use of the following substances to the noted percentage content (mass):

Lead 0,1%

Mercury 0,1%

Cadmium 0,01%

Hexavalent chromium 0,1%

Polybrominated biphenyls (PBB) 0,1%

Polybrominated diphenyl ethers (PBDE) 0,1%

Bis(2-Ethylhexyl) phthalate (DEHP) 0,1%

Benzyl butyl phthalate (BBP) 0,1%

Dibutyl phthalate (DBP) 0,1%

Diisobutyl phthalate (DIBP) 0,1%

Allectra GmbH has taken all reasonable steps to verify the supply line information regarding the compliance with RoHS standards.

Products supplied by Allectra GmbH comply to the noted RoHS standards and/or can be used to produce items according to the RoHS directive.

Allectra GmbH declares the use of the following RoHS excemptions for RoHS compliant devices containing more than 0.1% lead (Pb) per weight:

RoHS Annex III excemption 6(b): "Lead as an alloying element in aluminium containing up to 0,4 % lead by weight"

RoHS Annex III excemption 6(c): "Copper alloy containing up to 4 % lead by weight"

RoHS Annex III excemption 7(a): "Lead in high melting temperature type solders"

RoHS Annex III excemption 7(c)-I: "Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound"

Schönfließ, 15.01.2025

Responsible: Bernhard Luckscheiter General Manager

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All data given in this sheet are carefully checked but subject to change at any time